

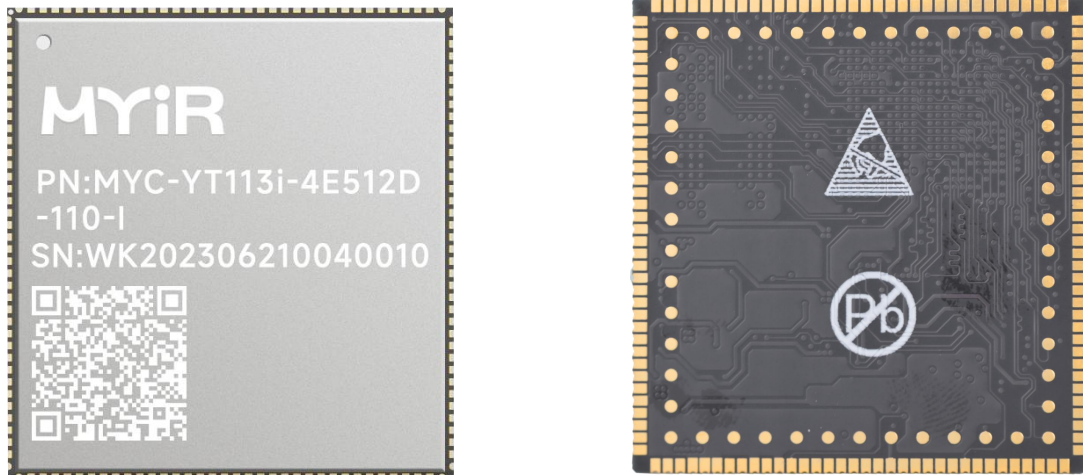
MYC-YT113i System-On-Module Overview



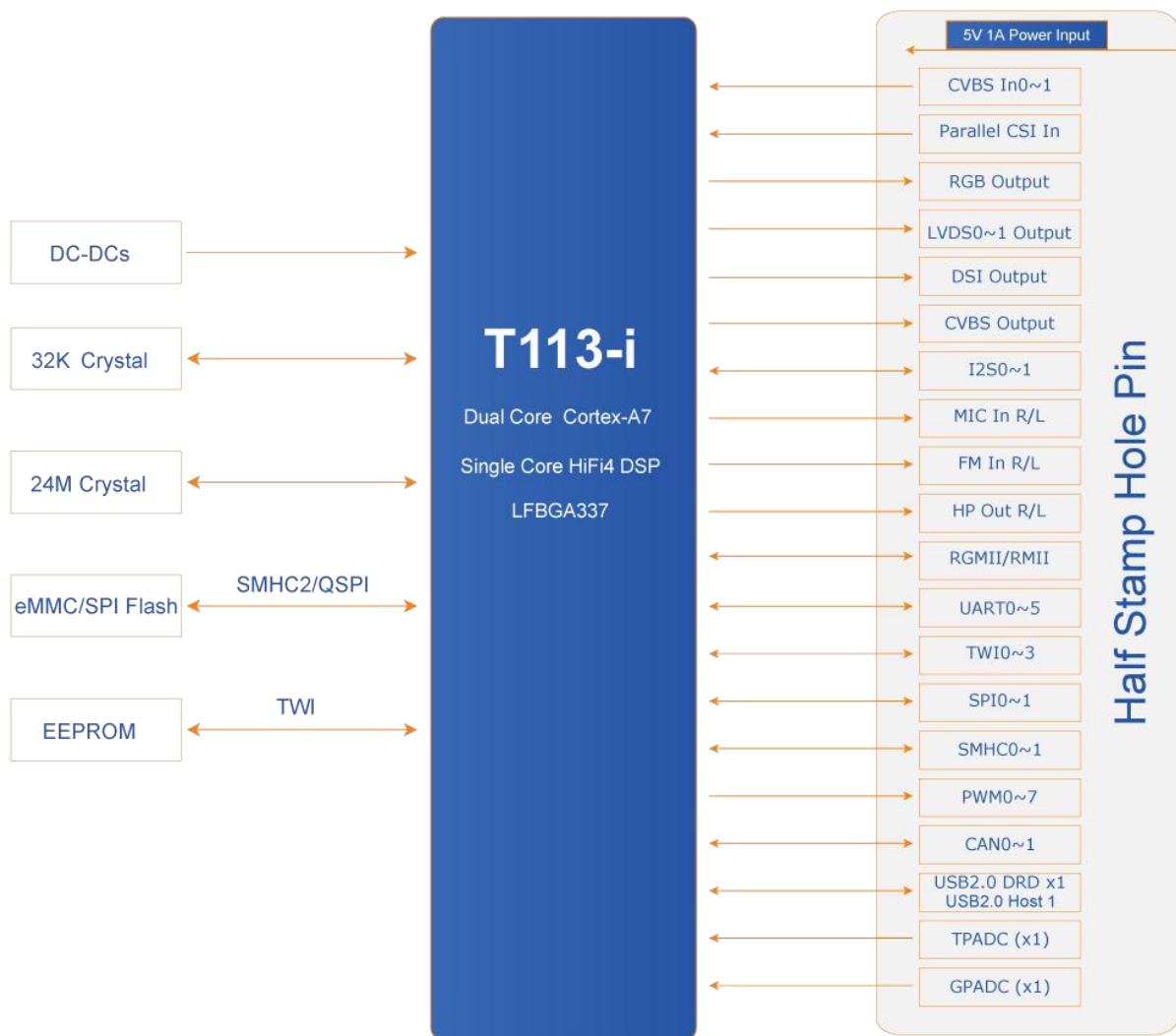
- ✓ Up to 1.2GHz Allwinner T113-i Dual-core ARM Cortex-A7 MPU with Single-core HiFi4 DSP
- ✓ 512MB/1GB DDR3, 4GB/8GB eMMC or 256MB Nand Flash, 32KB EEPROM
- ✓ 1.0mm pitch 140-pin Stamp Hole Expansion Interface + 50-pin LGA
- ✓ Supports Running Linux OS



Measuring only 37mm by 39mm, the MYC-YT113i SOM has the same 140-pin Castellated-Hole expansion interface pinout signals with the MYC-YT113X SOM but supporting larger capacities of external DDR3 memory (512MB/1GB), while the MYC-YT113X is fixed at 128MB on-chip DDR3 memory. It is based on **Allwinner T113-i** processor which features up to 1.2GHz Dual-core ARM Cortex-A7 MPU with a RISV slave core and a single-core HiFi4 DSP. The standard configurations have 4GB/8GB eMMC and 256MB Nand Flash options. It is capable of running Linux and suitable for applications such as HMI, industrial automation, display and control terminals.

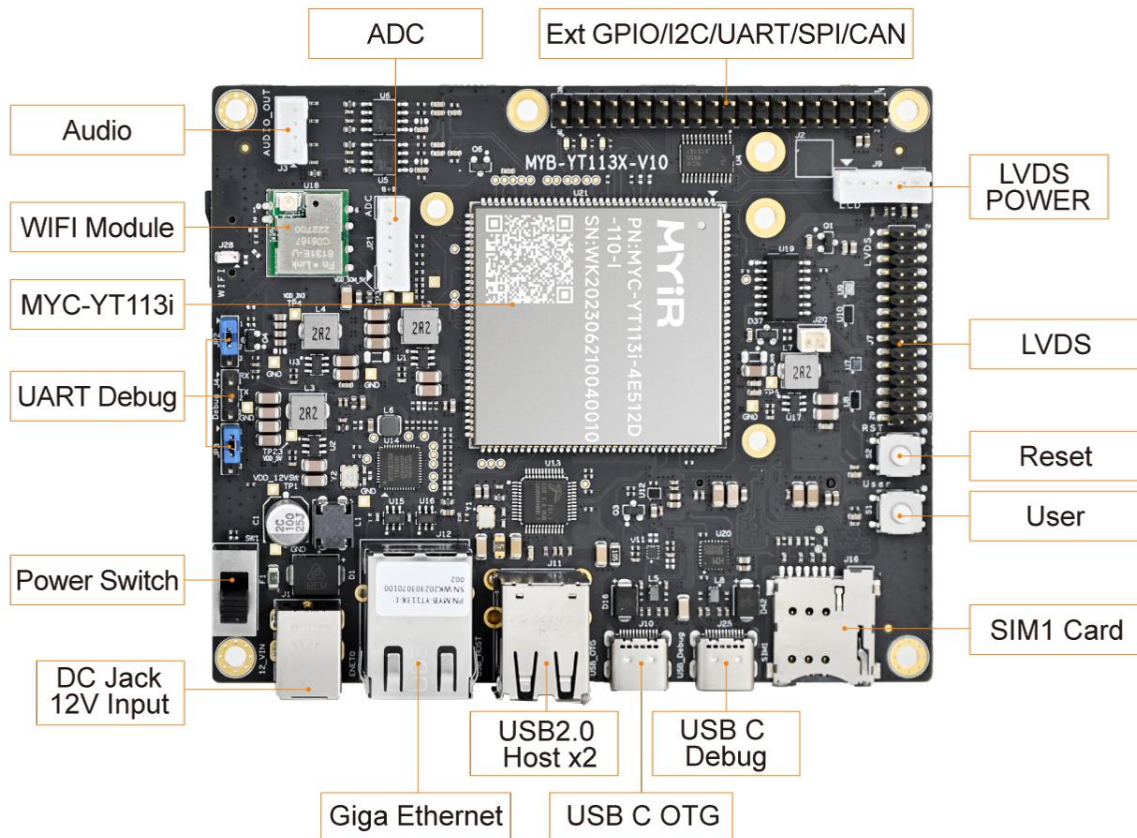


MYC-YT113i SOM (Top-view and Bottom-view)

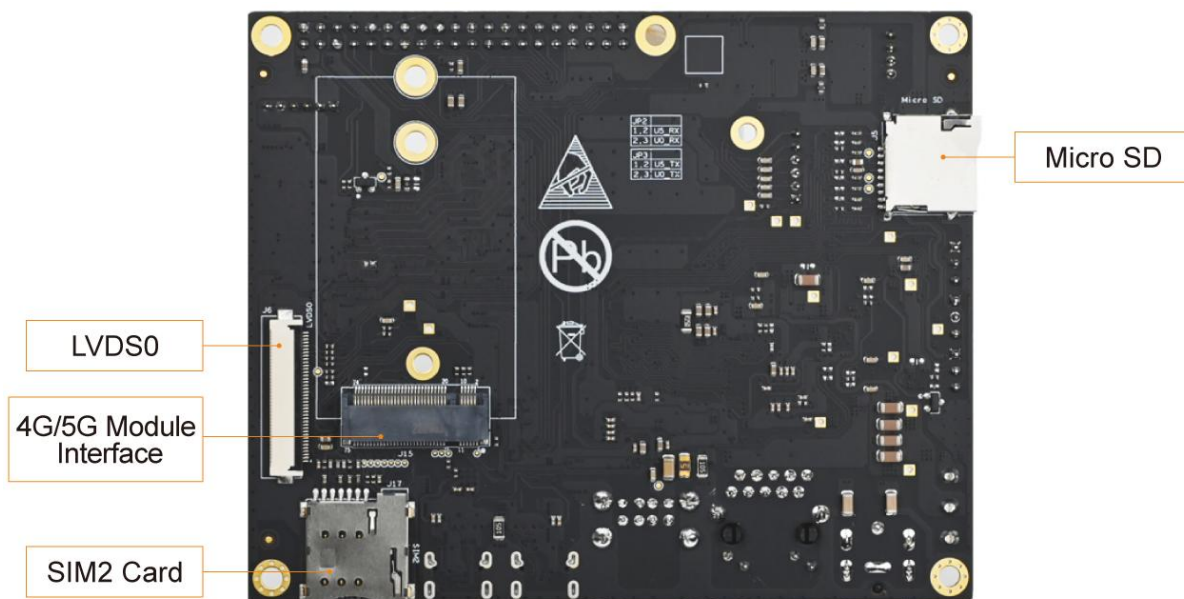


MYC-YT113i Function Block Diagram

The MYD-YT113i Development Board is built around the MYC-YT113i SOM and has explored a rich set of peripherals and interfaces to the base board including serial ports, one Gigabit Ethernet, two USB 2.0 HOST and one USB 2.0 OTG, one Micro SD card slot, one M.2 Socket for USB based 4G/5G LTE Module with two SIM card holders, one USB2.0 based WiFi module, one GPIO/I2C/UART/SPI/CAN extension header, Audio input/output and LVDS display interface.



MYD-YT113i Development Board Top-view



MYD-YT113i Development Board Bottom-view

MYIR also offers MY-WIREDCOM RPI Module (RS232/RS485/CAN) and MY-LVDS070C LCD Module as options for the MYD-YT113i Development Board to enhance the functionality of the board.

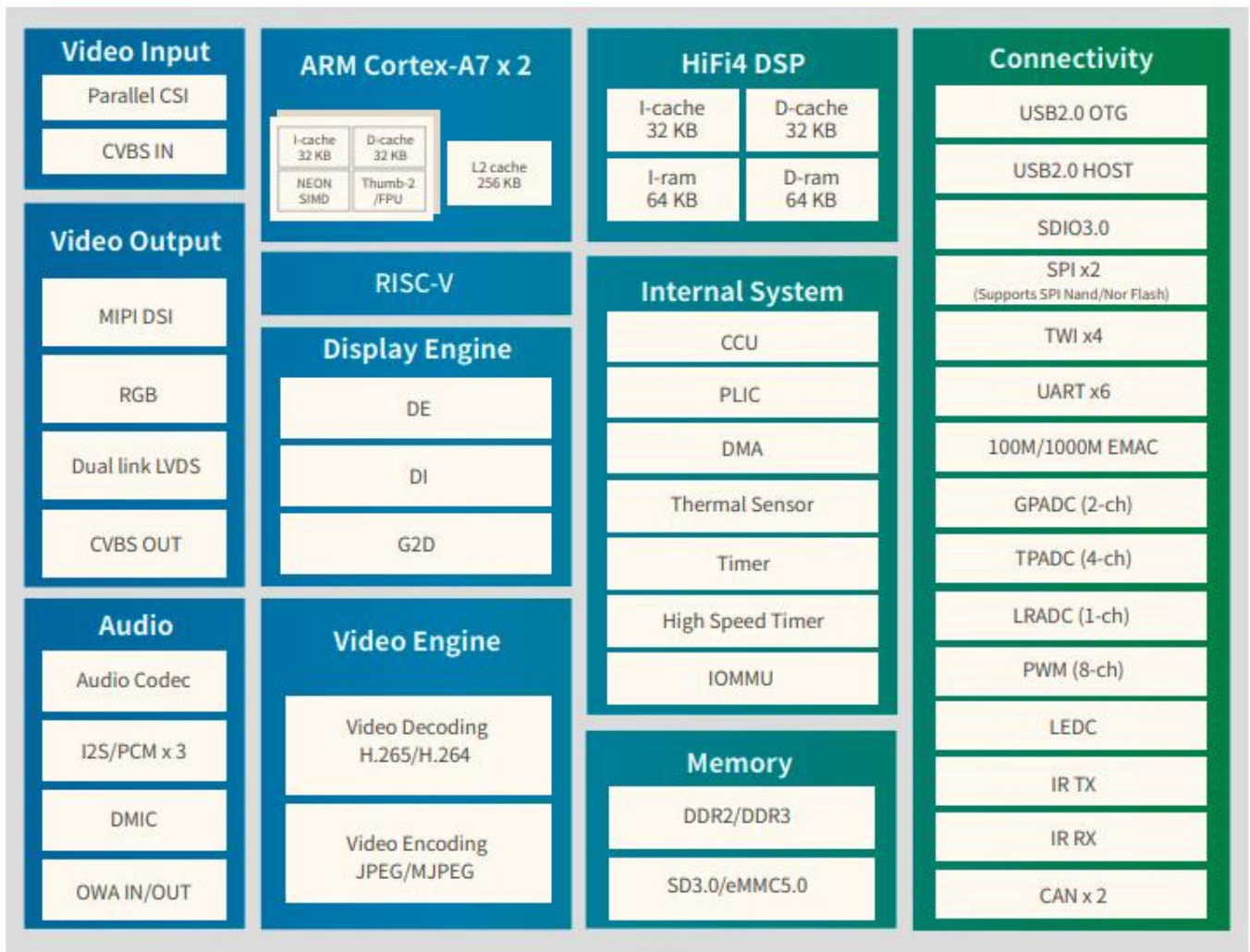


Hardware Specification

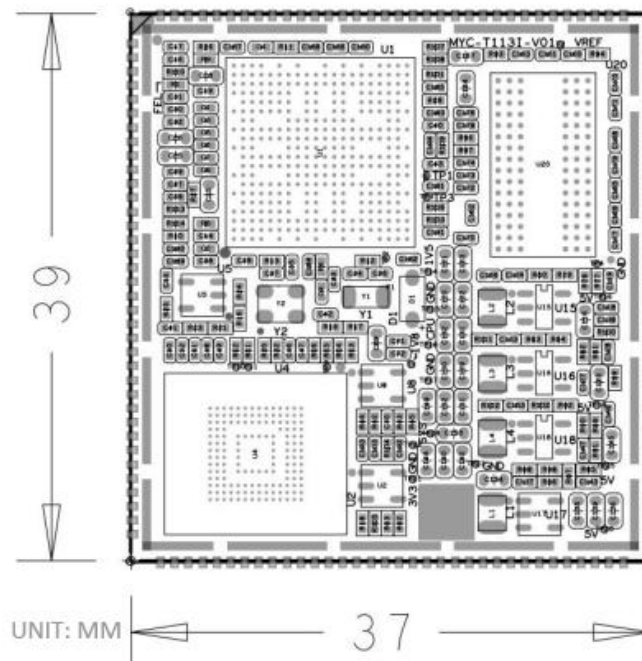
The MYC-YT113i SOM is using 13 x 13 mm, 337-LFBGA package Allwinner T113-i processor which is the Multi-Media decoding platform. T113-i integrates a 64-bit Xuantie C906 RISC-V CPU, a dual-core Arm Cortex-A7 CPU, and a HiFi4 DSP to provide the high-efficient computing power. It supports the full format decoding such as H.265, H.264, MPEG-1/2/4, JPEG, etc. The independent encoder can encode in JPEG or MJPEG. Integrated multi ADCs/DACs and I2S/PCM/DMIC/OWA audio interfaces can work seamlessly with the CPU to accelerate multimedia algorithms and improve the user experience. T113-i supports RGB/LVDS/MIPI DSI/CVBS OUT display output interfaces to meet the requirements of the different screen display. T113-i comes with extensive connectivity and interfaces, such as USB, SDIO, EMAC, TWI, UART, SPI, PWM, GPADC, LRADC, TPADC, IR TX&RX, etc. Besides, T113-i can connect with other different peripherals like Wi-Fi and BT via SDIO and UART.

Features	Description
CPU	● 64-bit Xuantie C906 RISC-V ● Dual-core ARM Cortex -A7 - 32 KB L1 I-cache + 32 KB L1 D-cache per core, and 256 KB L2 cache
DSP	● Single-core HiFi4 ● 32 KB I-cache + 32 KB D-cache ● 64 KB I-ram + 64 KB D-ram
Memory	● DDR2/DDR3, up to 2 GB ● SD3.0/eMMC 5.0, SPI Nor/NAND Flash
Video Engine	● Video decoding - H.265 up to 4K@30fps - H.264 up to 4K@24fps - H.263, MPEG-1/2/4, JPEG, Xvid, Sorenson Spark, up to 1080p@60fps ● Video encoding - JPEG/MJPEG up to 1080p@60fps - Supports input picture scaler up/down
Display Engine	● Allwinner SmartColor2.0 post processing for an excellent display experience ● Supports de-interlace (DI) up to 1080p@60fps ● Supports G2D hardware accelerator including rotate, mixer, lbc decompression
Video OUT	● CVBS OUT interface, supporting NTSC and PAL format ● RGB LCD output interface up to 1920 x 1080@60fps ● Dual link LVDS interface up to 1920 x 1200@60fps ● 4-lane MIPI DSI interface up to 1920 x 1080@60fps
Video IN	● 8-bit parallel CSI interface ● CVBS IN interface, supporting NTSC and PAL format
Audio	● 2 DACs and 3 ADCs ● Analog audio interfaces: MICIN1P/N, MICIN2P/N, MICIN3P/N, FMINL/R, LINEINL/R, LINEOUTLP/N, LINEOUTRP/N, HPOUTL/R ● Digital audio interfaces: I2S/PCM, DMIC, OWA IN/OUT
Connectivity	● USB2.0 OTG, USB2.0 Host ● SDIO 3.0, SPI x 2, UART x 6, TWI x 4, CAN x 2 ● PWM (8-ch), GPADC (2-ch), LRADC (1-ch), TPADC (4-ch), IR TX&RX ● 10/100/1000M EMAC with RMII and RGMII interfaces
Package	● LFBGA 337 balls, 13 mm x 13 mm

Features of T113-i Processor



Allwinner T113-i Block Diagram



MYC-YT113i Dimensions Chart



The MYC-YT113i SOM takes full features of T113-i processor and the main features are characterized as below:

Mechanical Parameters

- Dimensions: 37mm x 39mm
- PCB Layers: 8-layer design
- Power supply: +5V/1A
- Working temperature: -40~85 Celsius (industrial grade)

Processor

- Allwinner T113-i processor
 - Up to 1.2GHz Dual-core Arm Cortex-A7 CPU
 - Single-core HiFi4 DSP
 - Supports H.265/H.264 4K video decoding

External Memory

- 512MB/1GB DDR3
- 4GB/8GB eMMC or 256MB Nand Flash
- 32KB EEPROM

Peripherals and Signals Routed to Pins

- 1.0mm pitch 140-pin Stamp Hole Expansion Interface + 50-pin LGA
 - 1 x RGMII/RMII
 - 2 x USB2.0
 - 6 x UART
 - 2 x CAN
 - 4 x TWI
 - 2 x SPI
 - 1 x GPADC and 4 x TPADC
 - 1 x MIPI DSI
 - 2 x LVDS
 - 1 x RGB
 - 1 x CVBS Out (TV Out)
 - 1 x Parallel CSI
 - 2 x CVBS In (TV In)
 - 2 x I2S
 - Up to 81 GPIOs

Note: the peripheral signals brought out to the expansion interface are listed in maximum number. Some signals are reused. Please refer to the processor datasheet and the SOM pinout description file.



Software Features

The MYC-YT113i SOM supports Linux OS and comes with complete software package. The kernel and many peripheral drivers are available in source code to assist clients to expedite their development. The following are a summary of the software features:

Item	Feature	Description	Source Code
Bootloader	U-boot	Boot boot program uboot_2018.05	YES
Linux kernel	Linux kernel	Customized base on official kernel_5.4.61 version	YES
Device driver	USB Host	USB Host driver	YES
	USB OTG	USB OTG driver	YES
	I2C	I2C bus driver	YES
	SPI	SPI bus driver	YES
	Ethernet	YT8531SH driver	YES
	SDHI	EMMC/SD card storage driver	YES
	LVDS	LCD driver	YES
	Touch	Touch screen driver	YES
	Audio	SPDIF driver	YES
	Watchdog	Watchdog driver	YES
	4G/5G	4G/5G driver	YES
	PWM	PWM control driver	YES
	ADC	ADC driver	YES
	RTC	RTC driver	YES
	GPIO	Universal GPIO driver	YES
	UART	RS232/RS485/TTL driver	YES
	CAN	CAN driver	YES
	WIFI	RTL8731BU driver	YES
Images	t113i_linux_myir_emmc_core	Image built with Buildroot, excluding GUI interface	YES
	t113i_linux_myir_emmc_full	A fully functional image built with Buildroot	YES

MYC-YT113i Software Features



Order Information

Product Item	Part No.	Packing List
MYC-YT113i SOM	MYC-YT113i-256N256D-110-I	✓ One MYC-YT113i SOM
	MYC-YT113i-4E512D-110-I	
	MYC-YT113i-8E512D-110-I	
	MYC-YT113i-8E1D-110-I	
MYD-YT113i Development Board	MYD-YT113i-256N256D-110-I	✓ One MYD-YT113i Development Board (including MYC-YT113i SOM) ✓ One USB to UART Debug cable ✓ One 12V/2A Power adapter ✓ One DC Power jack adapter ✓ One Quick Start Guide
	MYD-YT113i-4E512D-110-I	
	MYD-YT113i-8E512D-110-I	
	MYD-YT113i-8E1D-110-I	
MY-LVDS070C 7-inch LCD Module	MY-LVDS070C	Add-on Options ✓ MY-LVDS070C 7-inch LCD Module ✓ MY-WIREDCOM Module
MY-WIREDCOM RPI Module	MY-WIREDCOM	
<i>Note:</i> 1. One MYD-YT113i Development Board includes one SOM MYC-YT113i mounted on the base board. If you need more SOM, you can order extra ones. 2. Discounts are available for bulk orders. 3. We provide OEM/ODM services to reduce time and save cost for customers.		



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